

New pixellized Micromegas detectors for the COMPASS experiment

Damien Neyret CEA Saclay IRFU/SPhN 12/06/2009

- The present MM detectors of the COMPASS experiment

- Future requirements and the projected Micromegas

The COMPASS experiment at CERN



The present Micromegas detectors

I r f u
 \bigcirc
 \bigcirc
saclay1st use in a part. physics exp.
Prototypes 1999-2000
Final detectors in 2001Saclay**R&D for COMPASS needs**
Large size 40x40 cm² with deported
electronics
Reduction of discharge rate
Light gas Ne + 10% C_2H_6 (+ 10%)
 CF_4)

Read-out electronics

Low noise electronics SFE16 (threshold ~ 4000 e⁻) TDC digitization leading + trailing edges

> 12000 channels



Performances of the Micromegas detectors



saclay

Main characteristics

3.2 → 5.5mm / 100µm gaps
5µm Ni meshes → copper (2006)
HV 800V / 390-420V
Gain 3000 to 6000

Detection efficiencies

- ~ 98-99% low particle flux
- ~ 96% high flux, up to 150kHz / channel





Performances of the Micromegas detectors



Discharges in COMPASS MM detectors

Discharges rate and effect optimized

Light gas $Ne-C_2H_6(-CF_4)$ selected Moderate gain with low noise electronics

Each strip decoupled → small recovery time

→ Ok with muon beam

<0.1 disch./spill at high µ flux

But close to the limits with hadron beam

Drift gap already increased in 2006-2007 (3.2 \rightarrow 5.5mm) 0.5 to 1 disch./spill with 4.10⁷h/spill

Larger rate may reduce efficiency and damage the detector



lrfu

saclay

Motivations and objectives for a new Micromegas R&D project

lrfu

saclay

New proposal discussed in COMPASS collaboration

Several physics programs (GPDs, Drell-Yann, hadron spectroscopy, hadron spin structure)

Muon and hadron beams with higher flux + various targets COMPASS detectors will continue to run for many years

$\rightarrow\,$ Opportunity for the evolution of the MM detectors

Objectives for a new detector

Stand 5 times higher flux hadron beams Detectors active in beam area in order to replace thick scintillating fibers Lighter electronics with 2 times more channels Improve the reliability of the detectors and the environment

Goals of the R&D project: to design a new Micromégas detector with Read-out with pixels in the detector center (beam area) 10 to 100 times less discharges Integrated electronics (APV25 chips) Robustness improved (bulk technology)

Pixels read-out in the detector center



~1300 pixels + ~1000 strips to read

How to reduce discharges rate ?

Resistive layer on top of the strip

Irfu

saclay

Reduce effect and amplitude of the discharges Several solutions (resistive foil on isolating layer, resistive coating on strip, etc..)

Studies launched in particular by Saclay sLHC group, common studies to be done also with other groups (Clas12, ILC,...)

Tests foreseen during October RD51 beam



Additional GEM foil above the mesh

Charge spread + lower gain of the MM layer \rightarrow less discharges Also to be tested in October

Segmentation of the mesh

Lower mesh capacitance → smaller discharge and faster recovery

Read-out with APV25 chips

SFE16 + TDC electronics not convenient enough

1024 channels/detector \rightarrow 64 SFE16 cards, 16 F1 cards No more space available

~400W per detector \rightarrow high power cooling required

saclay Integrated electronics based on APV25 chips

128 channels amplifier and multi-sample analog multiplexer Digitization by flash ADC with noise common mode correction and zero suppression

Already used at Compass: Silicon, GEM, Rich MWPC

TUM Munich card for pGEM adapted to MM (protection circuit with strips decoupling) + tuning of APV configuration

Low cost, $< 5 \in h$.



12 June 2009

lrfu

Improved robustness with bulk technology

A few issues with the old MM detectors

Low material budget: thin epoxy layers (100µm) on honeycomb, sometimes gluing defaults of the epoxy layer
 Difficulties to tight thin mesh → sometimes slightly folded or not flat Shorts or current leaks between mesh and strips (dust, impurities)



Monolithic detector with the bulk technology

Techno. developed at Saclay, can be produced by CERN lab. Inox mesh laminated on detector, with photosensitive coverlay Mesh fixed on board, dust tight, less sensitive to gluing defaults Bulk process on honeycomb board ? How about high hadron flux ? (gain, discharge rate)

lrfu

saclay

2008 tests with COMPASS detectors



2 MM detectors shifted to have beam in active area

To study behavior of MM at high muon and hadron beams flux





130 kHz/ch, 2-3 disch./spill



Present activities

lrfu

saclay

Prototypes of pixellized Micromégas

32x32 1mm² pixels in the center, 30cm strips

Original design from TUM Munich, adapted by CEA Saclay + CERN

Kapton board, 2 faces used, built by CERN lab

Read-out by APV electronics, pGEM cards + new cards with MM protection circuit under production



Two prototypes: bulk and non-bulk

Non-bulk using standard 5µm copper mesh, 100µm amplification gap Bulk with 30µm inox mesh, 125µm gap No other difference

Goal: study performances and impact of thick mesh (discharge rate)

Ongoing work with prototypes

Non-bulk prototype

saclay

lrfu

Tested with source: same gain as present Micromegas detectors, similar gain between pixels and strips
Installed at Compass end of May
Discharge rate with hadron beam similar to 2008 shifted MM detectors
Electronics noise figure as expected
No results on resolution and efficiency yet
Tests with new APV card prototypes ongoing





Ongoing work with prototypes

Bulk prototype



saclay

Difficulties to apply bulking process on large size honeycomb
A lot of R&D in CERN lab to overcome them
Delivered end of February
A few issues: bad gluing, impurities in amplification gap, current leak, discharges
Finally working: up to 540V in Ne-C₂H₆-CH₄ gas

Gain slightly larger than the non-bulk prototype To be tested at Compass end of June



New pixellized Micromegas detectors for the COMPASS experiment

Time line



Validation of the final prototype with discharge reduction Proposition to the collaboration



Le circuit APV25-S1



Gain comparison, strips in or outside beam

Irfu CCCC saclay



Time over threshold distribution (ToT)

- No gain loss ToT peak centered at same value
- Pile-up : tail with larger ToT when beam IN efficiency loss: 10-20%

CEA DSM Irfu

